IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Perry, Guy

Serial No. Confirmation No.

6524

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re Application of

August 10, 2001

09/927,675

For

Bond Pad Structure Comprising Multiple Bond Pads with

Metal Overlap

CERTIFICATION UNDER 37 CFR 1.8(a) and 1.10

I hereby certify that, on the date shown below, this correspondence is being:

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**Transmission** 

transmitted by facsimile to Fax No.: addressed to Examiner at the Patent and Trademark Office

Date: October 16 . 2001

**Assistant Commissioner for Patents** 

Washington, D.C. 20231

## INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.97/98

In compliance with Applicant's duty of disclosure as set forth in 37 C.F.R. §1.56, listed on the attached equivalent to Form PTO-1449 are those patents and other publications known to the Applicant which may be considered material to the patentability of the claims of the above-captioned application.

The Applicant respectfully requests that the documents listed on the attached equivalent to Form PTO-1449 be considered by the Examiner, that these references be made of record in the present applicant, and that an initialed copy of the attached equivalent to Form PTO-1449 be returned to the undersigned in accordance with MPEP 609.

Respectfully submitted,

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